



41  
1765  
C3

PATENT  
Atty. Dkt. No. AMAT/6060/CMP/ECP/RKK

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:  
Olgado, et al.

Serial No.: 10/043,561

Confirmation No.: 7947

Filed: January 8, 2002

For: SYSTEM FOR PLANARIZING  
METAL CONDUCTIVE LAYERS

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

§ Group Art Unit: 1765

§ Examiner: Kin Chan Chen

**CERTIFICATE OF MAILING**  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on  
9/24/03, 2003 with the United States Postal Service as  
First Class Mail in an envelope addressed to: Commissioner  
for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

9/24/03 Kin Chan Chen  
Date Signature

### RESPONSE TO OFFICE ACTION DATED JUNE 24, 2003

In response to the Office Action dated June 24, 2003, having a shortened statutory period for response set to expire on September 24, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. The Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6060/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are shown in the listing of the claims which begins on page 2 of this paper. **Amendments to the Drawings** begin on page 10 of this paper and include both attached replacement sheets and annotated sheets showing changes. **Remarks/Arguments** begin on page 11 of this paper.